9.27.02 Form PTO-1595 (Rev. 03/01) OMB No. 0651-0027 (exp. 5/31/2002)	10-03-		U.S. DEPARTMENT OF COMMER U.S. Patent and Trademark Of	
To the Honorable Commissioner of	102240	1142	∍d original documents or copy there	of
Name of conveying party(ies): Hiroyuki Matsumoto			ess of receiving party(ies) Manufacturing Co., Ltd.	
Additional name(s) of conveying party(ies) 3. Nature of Conveyance: X Assignment Merger		Street Address: Murata Manufacturing Co., Ltd. (A170) Intellectual Property Department 26-10, Tenjin 2-chome, Nagaokakyo-shi		
Security Agreement	Change of Name	City: <u>Kyoto-fu</u>		
Other		State: <u>Japan</u>	Zip: <u>617-8555</u>	
Execution Date: Septem	nber 21, 2002	Additional name(s address(es) attac		
•	ith a new application, the execution of	B. Patent No.(s):	application is: September 21, 200	<u>)2</u>
Name and address of party to whom correspondence concerning document should be mailed:		6. Total number of applications and patents involved: 1		
Name: Edward A. Meilman DICKSTEIN SHAPIRO MORIN & OSHINSKY LLP		7. Total fee (37 CF	FR 3.41) \$ <u>40.00</u>	
Internal Address: Atty. Dkt.: M1071.1776/P1776 Street Address: 1177 Avenue of the Americas 41st Floor		Enclosed Authorized to be charged to deposit account X Authorized to be charged to credit card (Form 2038 enclosed)		
City: Star New York NY	te: Zip: 10036-2714	8. Deposit accoun	t number: 50-2215 y of this page if paying by deposit accord	unt)
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Statement and signature. To the best of my knowledge and is a true copy of the original documents.		rmation is true and o	correct and any attached copy	

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02 FC:581 40.00 GP

Edward A. Meilman Name of Person Signing

Total number of pages including cover sheet, attachments, and documents:

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PATENT REEL: 013338 FRAME: 0783

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September 27, 2002

PATENT APPLICATION ASSIGNMENT M1071.1776 SOLE OR JOINT INVENTORS EXECUTED OUTSIDE U.S.A. FILE NO.

WHEREAS, I, Hiroyuki Matsumoto, as assignor, have invented certain improvements in METHOD OF MANUFACTURING MONOLITHIC CERAMIC ELECTRONIC PART AND MONOLITHIC CERAMIC ELECTRONIC PART or which an application for United States Letters Patent has been executed by us of even date herewith; and

WHEREAS, Murata Manufacturing Co., Ltd., 26-10, Tenjin 2-chome, Nagaokakyo-shi, Kyoto-fu 617-8555, Japan, as assignee, is desirous of acquiring all right, title and interest in and to said invention and any Patent that may be granted therefor.

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledged, I, as assignor, hereby sell, assign and set over to said assignee the entire right, title and interest for the United States and all other countries in and to said invention and the aforesaid application for Patent, all original, divisional, continuation, substitute or reissue applications and patents applied for or granted therefor in the United States and all other countries, including all rights of priority from the filing of said application, and all rights for past infringement, and the Commissioner of Patents and Trademarks is hereby authorized and requested to issue all patents on said inventions or resulting therefrom to said assignee herein, as assignee of the entire interest therein; and the undersigned for myself and my legal representatives, heirs and assigns do hereby agree and covenant without further remuneration, to execute and deliver all divisional, continuation, reissue and other applications for Patent on said inventions and all assignments thereof to said assignee or its assigns, to communicate to said assignee or its representatives all facts known to the undersigned respecting said inventions, whenever requested, to testify in any interferences or other legal proceedings in which any of said applications or patents may become involved, to sign all lawful papers, make all rightful oaths, and to do generally everything necessary to assist assignee, its successors, assigns and nominees to obtain patent protection for said invention in the United States and all other countries, the expenses incident to said applications to be borne and paid by said assignee.

Date: 21/9/2002 Niroyuki Matsumoto
Hiroyuki MATSUMOTO

LEGALIZATION RECOMMENDED

RECORDED: 09/27/2002

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